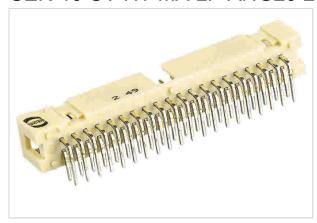


# SEK-19 SV HT MA LP ANG29 20P PLS4



Part number	09 19 520 5323
Specification	SEK-19 SV HT MA LP ANG29 20P PLS4
HARTING eCatalogue	https://b2b.harting.com/09195205323

Image is for illustration purposes only. Please refer to product description.

# Identification

Category	Connectors
Series	SEK Low-profile
Element	Male connector
Description of the contact	Angled

## Version

Termination method	Reflow soldering termination (THR)
Connection type	PCB to cable  Motherboard to daughtercard
Number of contacts	20
Termination length	2.9 mm

## Technical characteristics

Contact rows	2
Contact spacing (termination side)	2.54 mm
Rated current	1 A
Insulation resistance	>10 <sup>9</sup> Ω
Contact resistance	≤20 mΩ
Limiting temperature	-55 +125 °C (during reflow soldering max. +240 °C for 60 s)
Insertion and withdrawal force	≤40 N
Performance level	NM 30 (S4)
Mating cycles	≥250
Test voltage U <sub>r.m.s.</sub>	1 kV



# Technical characteristics

Isolation group	II (400 ≤ CTI < 600)
<u> </u>	

# Material properties

Thermoplastic resin (PCT)
Beige
Copper alloy
Noble metal over Ni Mating side Sn over Ni Termination side
≥0.76 µm
≥30 µinch
V-0
compliant
compliant
е
Not contained
Not contained
Not contained
Yes
Lead Nickel
R26

# Specifications and approvals

Specifications	IEC 60603-13
UL / CSA	UL 1977 ECBT2.E102079
	CSA-C22.2 No. 182.3 ECBT8.E102079

## Commercial data

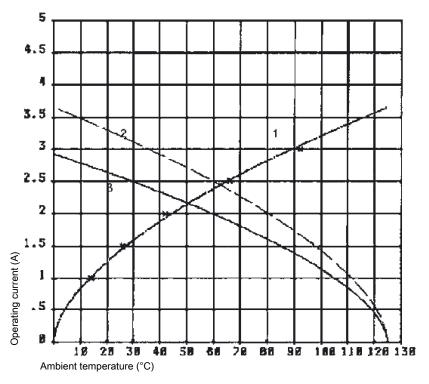
Packaging size	100
Net weight	4.36 g
Country of origin	Romania
European customs tariff number	85366990
GTIN	5713140211933
eCl@ss	27460201 PCB connector (board connector)



#### Current carrying capacity

The current carrying capacity of the connectors is limited by the thermal load capability of the contact element material including the connections and the insulating parts. The derating curve is therefore valid for currents which flow constantly (non-intermittent) through each contact element of the connector evenly, without exceeding the allowed maximum temperature.

Measuring and testing techniques acc. to IEC 60512-5-2



- ① Temperature raise
- ② Derating curve
- 3 Derating curve 80%

## Cross section of solder termination

